

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



FCH104N60F_F085

N-Channel SuperFET II FRFET MOSFET

600 V, 37 A, 104 mΩ

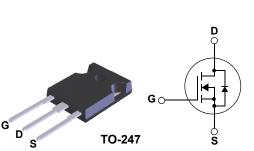
Features

- Typical $R_{DS(on)}$ = 91 m Ω at V_{GS} = 10 V, I_D = 18.5 A
- Typical Q_{a(tot)} = 109 nC at V_{GS} = 10V, I_D = 18.5 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive.

SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/TO/ TO247A03.pdf

Application

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



November 2014

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage		600	V
V _{GS}	Gate to Source Voltage		±20	V
		T _C = 25°C	37	А
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 100°C	24	А
	Pulsed Drain Current		See Fig 4	А
E _{AS}	Single Pulse Avalanche Rating	(Note 2)	809	mJ
du/dt	MOSFET dv/dt		100	V//mm
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	50	V/ns
	Power Dissipation		357	W
P _D	Derate Above 25°C		2.85	W/ ^o C
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	°C
$R_{\theta JC}$	Maximum Thermal Resistance Junction to Case		0.35	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambie	ent (Note 4)	40	°C/W

Maximum Ratings T_C = 25°C unless otherwise noted

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH104N60F	FCH104N60F_F085	TO-247	-	-	30

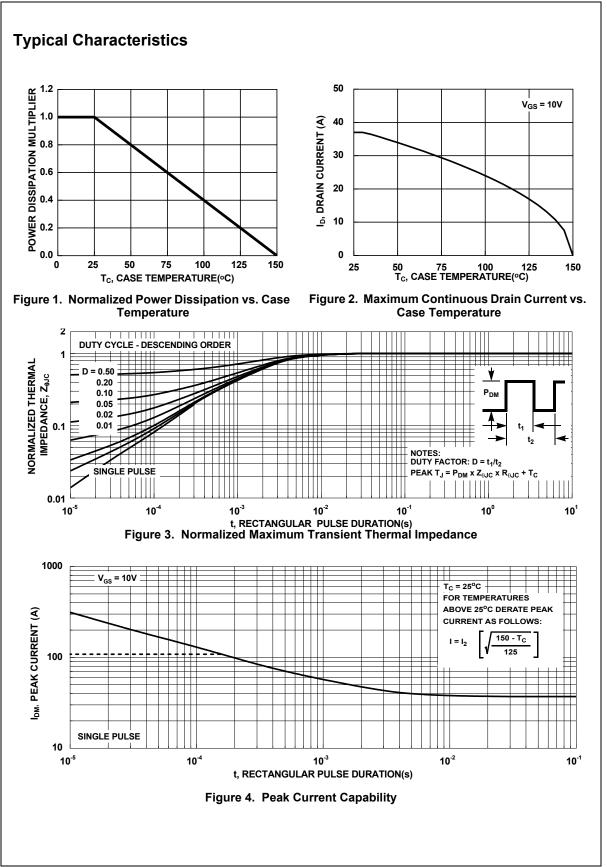
Notes:

1: Current is limited by bondwire configuration.

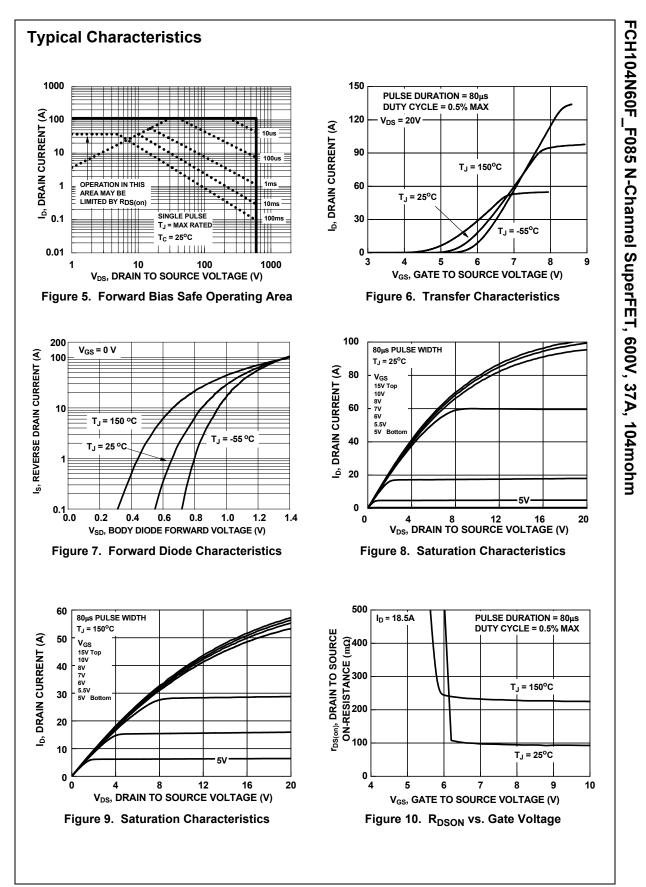
2: Starting T_J = 25°C, L = 35mH, I_{AS} = 6.8A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche. 3: I_{SD} ≤ 18.5A, di/dt ≤ 200 A/us, V_{DD} ≤ 380V, starting T_J = 25°C.

4: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA}is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

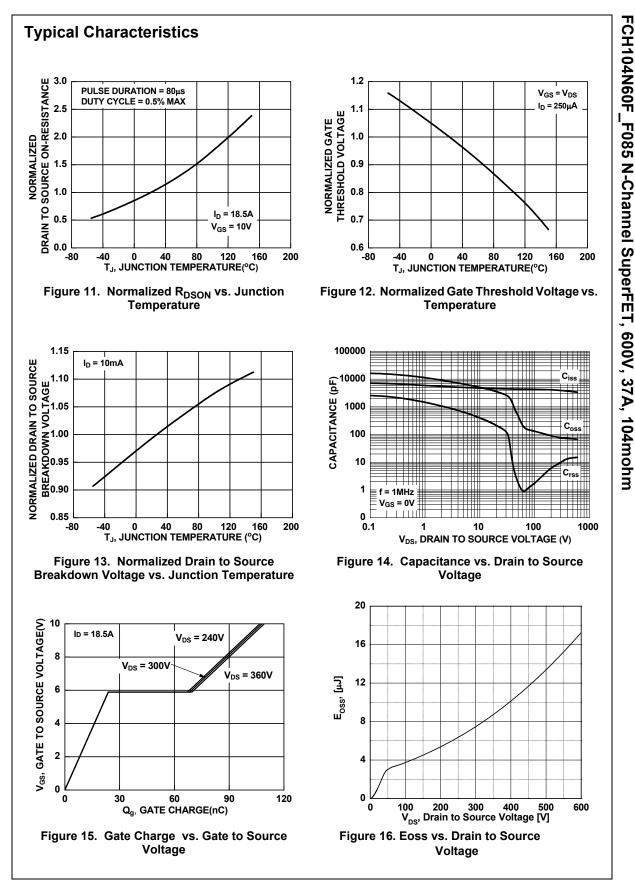
$\begin{array}{c cr} \hline l_{GSS} & \hline Gate to Source Leakage Current & V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline On Characteristics & & & & & & \\ \hline V_{GS}(m) & \hline Drain to Source On Resistance & V_{GS} = V_{DS}, I_D = 250 \mu A & 3.0 & 4.0 & 5.0 \\ \hline I_D = 18.5A, & V_{GS} = 10V & T_J = 25^\circ C & - & 91 & 104 \\ \hline V_{JS} = 100V, V_{GS} = 10V & T_J = 150^\circ C(Note 5) & - & 217 & 275 \\ \hline Dynamic Characteristics & & & & \\ \hline C_{iss} & Input Capacitance & V_{DS} = 100V, V_{GS} = 0V, & - & 134 & - & - \\ \hline C_{coss} & Output Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{coss} & Output Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{rss} & Reverse Transfer Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{gl}(ToT) & Total Gate Charge & V_{DD} = 380V & I_D = 18.5A & - & 8 & 11 & - & - \\ \hline Q_{gd} & Gate to Drain "Miller" Charge & V_{CS} = 10V & - & - & 46 & - & - \\ \hline Switching Characteristics & & & & \\ \hline t_{off} & Turn-On Time & V_{CS} = 10V, R_G = 4.7\Omega & - & - & 58 & 78 & - & - \\ \hline t_{off} & Turn-Off Time & & V_{CS} = 10V, R_G = 4.7\Omega & - & - & - & - & - & - \\ \hline T_{rr} & Reverse Recovery Time & I_F = 18.5A, V_{GS} = 0V & - & - & 1.2 & - & - & - & - \\ \hline T_{rr} & Reverse Recovery Time & I_F = 18.5A, V_{GS} = 0V & - & - & - & - & - & - & - & - & - & $	Symbol	Parameter	Test	Min	Тур	Max	Units	
$\begin{array}{ c c c c c c c c c } \hline \mbox{Drain to Source Leakage Current} & V_{DS}=600V, & T_J=25^{\circ}C & - & - & 10 \\ \hline \mbox{V}_{GS}=0V & T_J=150^{\circ}C(Note 5) & - & - & 1 \\ \hline \mbox{J}_{GSS} & Gate to Source Leakage Current} & V_{GS}=\pm 20V & - & - & \pm 100 \\ \hline \mbox{Dn Characteristics} & & & & & & & & & & & & & & & & & & &$	Off Cha	racteristics						
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Bunss	Drain to Source Breakdown Voltage	I _D = 250μA, V	7 _{GS} = 0V	600	-	-	V
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		-			-	-	10	μA
$\begin{array}{c c_{GSS} & Gate to Source Leakage Current & V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline \\ \hline On Characteristics \\ \hline \\ \hline \\ \hline On Characteristics \\ \hline \\ $	I _{DSS}	Drain to Source Leakage Current			-	-	1	mA
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	I _{GSS}	Gate to Source Leakage Current		0 ()	-	-	±100	nA
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	On Cha	racteristics						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Vcc(th)	Gate to Source Threshold Voltage	Vcc = Vpc Ir	a = 250µA	3.0	40	50	V
$\begin{array}{c c c c c c c } \hline \mbox{Data to Solute On Resistance} & V_{GS} = 10V & T_J = 150^{\circ}C(Note 5) & - & 217 & 275 \\ \hline \mbox{Dynamic Characteristics} \\ \hline \mbox{C}_{GS} & \mbox{Output Capacitance} & V_{DS} = 100V, V_{GS} = 0V, \\ \hline \mbox{f} = 1MHz & - & 134 & - & - & - & 134 & - & - & - & - & - & - & - & - & - & $	• GS(III)		$l_{\rm c} = 18.5$	$T_1 = 25^{\circ}C$	-			mΩ
$\begin{tabular}{ c c c c c c c } \hline Dynamic Characteristics \\ \hline Dynamic Characteristics \\ \hline C_{iss} & Input Capacitance & F = 10V, V_{GS} = 0V, & - & 4302 & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & - & 134 & - & - & - & - & - & - & 134 & - & - & - & - & - & - & - & - & - & $	r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 10V$		-			mΩ
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynami	ic Characteristics		• • • • • • • • • • • • • • • • • • •		1	1	1
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Cise	Input Capacitance			_	4302	-	pF
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Coss			V _{GS} = 0V,	-	134	-	, pF
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			=t = 1MHz	-	-	1.7	-	, pF
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			f = 1MHz		-	0.49	-	Ω
$ \begin{array}{ c c c c c c c c } \hline Source Gate Charge \\ Q_{g(th)} & Threshold Gate Charge \\ Q_{gs} & Gate to Source Gate Charge \\ Q_{gd} & Gate to Drain "Miller" Charge \\ \hline \\ $		Total Gate Charge			-	109	139	nC
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		-		-	-	8	11	nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $					-	23	-	nC
3° - 12 Switching Characteristics t_{on} Turn-On Time - 58 78 $t_{d(on)}$ Turn-On Delay Time - 35 - - t_r Rise Time V_{DD} = 380V, I_D = 18.5A, - 23 - $t_{d(off)}$ Turn-Off Delay Time V_GS = 10V, R_G = 4.7\Omega - 94 - t_f Fall Time - 98 131 - Drain-Source Diode Characteristics V_SD Source to Drain Diode Voltage I_{SD} = 18.5A, V_{GS} = 0V - - 1.2 T_{rr} Reverse Recovery Time I _F = 18.5A, dI_{SD}/dt = 100A/µs - 162 - Q_{rr} Reverse Recovery Charge V_{DD} = 480V - 1223 -			$v_{GS} = 10v$	-	-	46	-	nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Switch	ning Characteristics						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{on}	Turn-On Time				58	78	ns
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{d(on)}	Turn-On Delay Time		-	-	35	-	ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	t _r	Rise Time	V _{DD} = 380V,	I _D = 18.5A,	-	23	-	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(off)}	Turn-Off Delay Time			-	94	-	ns
VsdSource to Drain Diode VoltageIsdIsdIsd V_{SD} Source to Drain Diode VoltageIsd18.5A, VGS = 0V1.2 T_{rr} Reverse Recovery TimeIF = 18.5A, dISd/dt = 100A/ μ s-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	t _f	Fall Time			-	5	-	ns
V_{SD} Source to Drain Diode Voltage $I_{SD} = 18.5A$, $V_{GS} = 0V$ 1.2 T_{rr} Reverse Recovery Time $I_F = 18.5A$, $dI_{SD}/dt = 100A/\mu s$ -162- Q_{rr} Reverse Recovery Charge $V_{DD} = 480V$ -1223-	t _{off}	Turn-Off Time			-	98	131	ns
T_{rr} Reverse Recovery TimeIF= 18.5A, dI_{SD}/dt = 100A/µs-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	Drain-S	ource Diode Characteristics						
T_{rr} Reverse Recovery TimeIF= 18.5A, dI_{SD}/dt = 100A/ μ s-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	V _{SD}	Source to Drain Diode Voltage	I _{SD} = 18.5A, V _{GS} = 0V		-	-	1.2	V
Q_{rr} Reverse Recovery Charge $V_{DD} = 480V$ - 1223 -		Reverse Recovery Time			-	162	-	ns
		Reverse Recovery Charge			-	1223	-	nC
NOIES:	Notes:							
5: The maximum value is specified by design at T _J = 150°C. Product is not tested to this condition in production.	5: The max	kimum value is specified by design at T_J = 150)°C. Product is no	t tested to this condition	in produc	tion.		



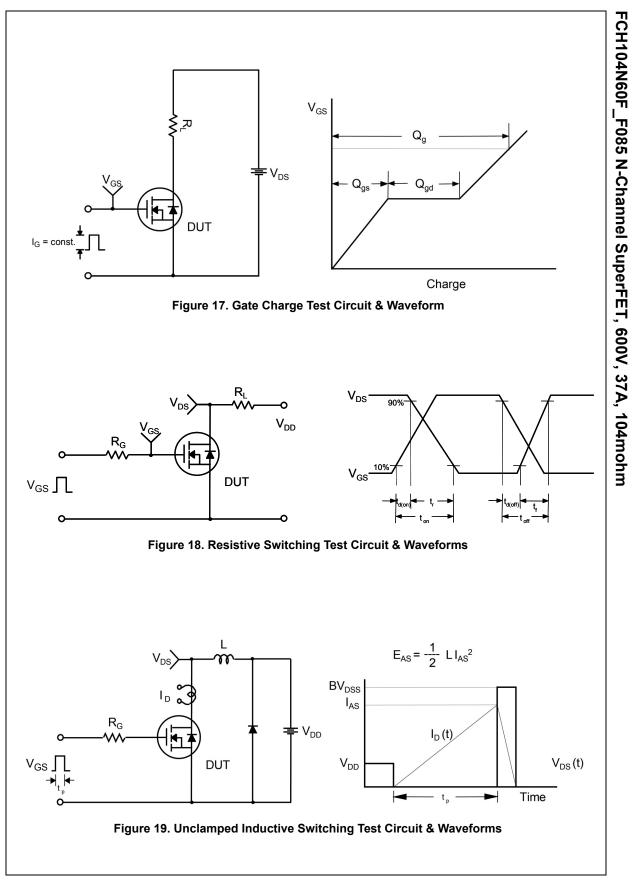
FCH104N60F_F085 N-Channel SuperFET, 600V, 37A, 104mohm



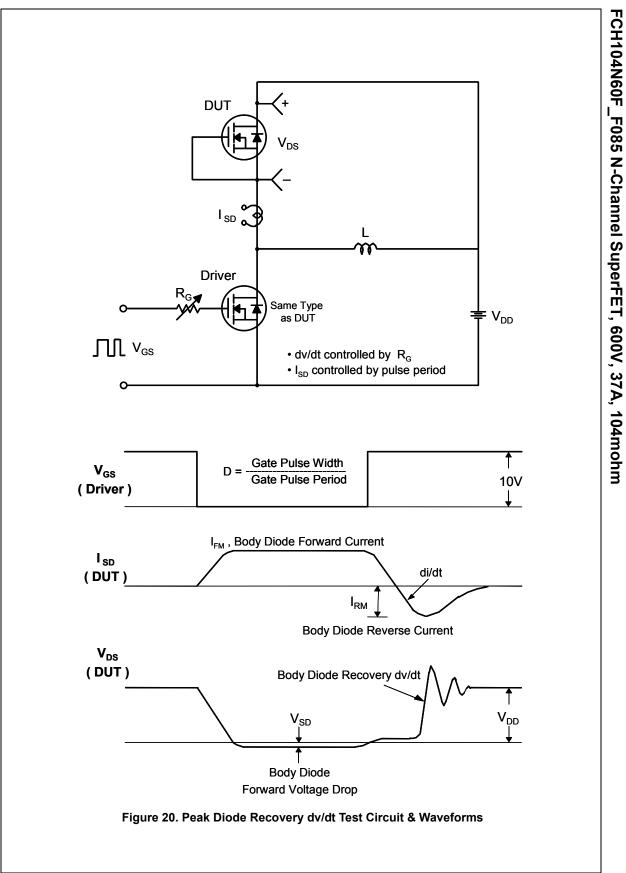
FCH104N60F_F085 Rev. B2

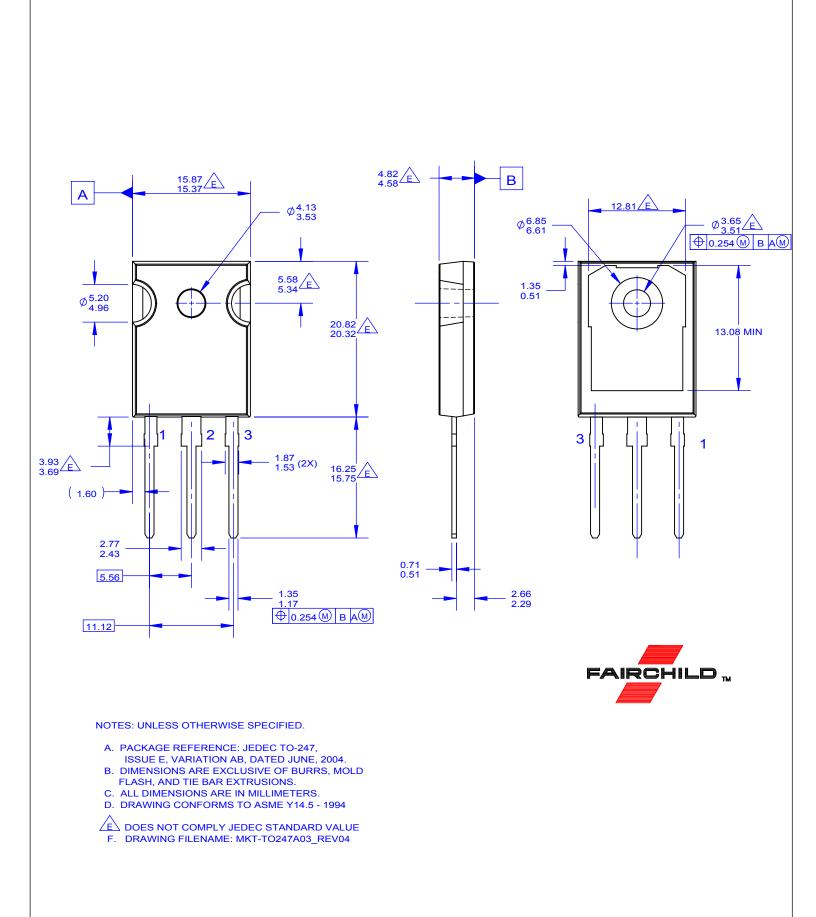






FCH104N60F_F085 Rev. B2





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi: FCH104N60F_F085